502272552 03/15/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Christian Gert BLUCHEL	03/28/2011
Yanmei WANG	03/28/2011

RECEIVING PARTY DATA

Name:	TEMASEK POLYTECHNIC	
Street Address:	21 Tampines Avenue 1	
City:	Singapore	
State/Country:	SINGAPORE	
Postal Code:	529757	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13837254

CORRESPONDENCE DATA

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NAME OF SUBMITTER: Daniel P. Lent

Total Attachments: 3 source=6M79814#page1.tif source=6M79814#page2.tif source=6M79814#page3.tif

> PATENT REEL: 030016 FRAME: 0398

CH \$40.00 1383725

DEED OF ASSIGNMENT

THIS DEED made the eighteen day of February two thousand and eleven (2011) BETWEEN,

- (1) <u>BLUCHEL</u> Christian Gert of c/o TEMASEK POLYTECHNIC Engineering Department 21 Tampines Avenue 1 Singapore 529757
- (2) WANG Yanmei of
 c/o TEMASEK POLYTECHNIC
 Engineering Department
 21 Tampines Avenue 1
 Singapore 529757

[hereinafter referred to as "the Assignors"]

<u>AND</u>

(1) TEMASEK POLYTECHNIC 21 Tampines Avenue 1 Singapore 529757

[hereinafter referred to as "the Assignee"]

<u>WHEREAS</u> the Assignors warrant that the Assignors are the inventors of an invention relating to an invention entitled "A Method Of Preparing A Substrate For Immobilization Of Functional Substances Thereon And The Substrate Obtained Therefrom" [hereinafter referred to as "the Invention"], the subject of International Patent Application No. PCT/SG2011/000069, including the designation of the United States of America [hereinafter referred to as "the Application"]

AND WHEREAS the Assignors have agreed to assign to the Assignee and the Assignee desires to take assignment of all rights, title and interest of the Assignors in and to the Invention and the Application,

PATENT REEL: 030016 FRAME: 0399

NOW THIS DEED WITNESSETH

- 1. In consideration of the sum of one dollar (\$1) and other good and valuable consideration receipt of which is hereby acknowledged by the Assignors, the Assignors hereby assign to the Assignee all of his rights, title and interest in and to the Invention and the Application including:
- (a) all rights and powers to make one or more applications for Letters Patent or other form of protection in the name of the Assignee in Singapore, the United States of America and in any other country of the world in respect of the Invention, and all rights, title and interest in and to any Letters Patent or other form of protection to mature from any such application,
- (b) the rights and powers to prosecute the Application and all rights, title and interest in and to any Patent or Patents granted thereon together with any extension of the term of any such Patent or Patents as may be granted, SAVE THAT nothing in this Deed shall prevent the filing or proceeding of an Application to which this Deed relates, in the name of the Assignors or Inventors where such filing or proceeding of such Application is beneficial to the interests of the Assignee
- the rights and powers to seek protection in countries other than Singapore by way of Patent, Petty Patent, Utility Model, Design Patent or other appropriate form of protection for the Invention, by way of application(s) for such protection made to the appropriate authorities in such other country or countries as the Assignee in its complete discretion may elect, whether or not any such foreign application(s) be made claiming International Convention priority from the Application hereby assigned
- (d) any Copyright owned by the Assignors in and to any drawings relating to the subject matter of the Invention together with the rights and powers such as subsist at the date of this Deed
- (e) to apply for registration of Copyright, Design, Design-Patent or like protection in the name of the Assignee in Singapore and in any other country of the world in respect of the subject matter of the said drawings and to any registration of Copyright, Design-Patent or like protection which matures from any such application, together with the rights to sue in respect of any infringement of that Copyright which may have occurred before the date of this Deed

PATENT REEL: 030016 FRAME: 0400

The Assignors agree, at the expense of the Assignee, to sign, execute and 2. deliver all documents, forms and papers reasonably required to be produced or obtained by the Assignee in connection with any application for Letters Patent or other form of protection for the subject matter of the Invention, in Singapore or elsewhere.

IN WITNESS WHEREOF the Assignors and Assignee executed this Deed the day and year first hereinbefore written.

ASSIGNORS

SIGNED, SEALED and DELIVERED By the said **BLUCHEL** Christian Gert

in the presence of:

Er Jui Pin

·······Centre Manager

(Witnessedical Engineering Research Centre Temasek Polytechnic

SIGNED, SEALED and DELIVERED

By the said WANG Yanmei

in the presence of:

Er Jui Pin /

(WARRESManager L Biomedical Engineering Research Centre

Temasek Polytechnic

28 March 2011

28 March 2011

ASSIGNEE

FOR AND ON BEHALF OF By the said TEMASEK POLYTECHNIC

in the presence of:

Song Kwok Jun (Witness) Plort

Lay-Tan Siok Lie Deputy Principal

> **PATENT REEL: 030016 FRAME: 0401**

RECORDED: 03/15/2013